



SEMITRANS® 4

Ultrafast IGBT Modules

SKM 800GA125D

Features

- Homogeneous Si
- NPT-IGBT
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability, self limiting to $6 \times I_C$

Typical Applications*

- Resonant inverters up to 100 kHz
- Inductive heating
- Electronic welders at fsw > 20 kHz

Remarks

- $I_{DC} \leq 500$ A limited by terminals
- Take care of over-voltage caused by stray inductances



GA

Absolute Maximum Ratings		$T_{case} = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}	$T_J = 25^\circ\text{C}$	1200	V
I_C	$T_J = 150^\circ\text{C}$	$T_{case} = 25^\circ\text{C}$	760
		$T_{case} = 80^\circ\text{C}$	530
I_{CRM}	$I_{CRM} = 2 \times I_{Crom}$	1200	A
V_{GES}		± 20	V
t_{psc}	$V_{CC} = 600$ V; $V_{GE} \leq 20$ V; $T_J = 125^\circ\text{C}$ $V_{CES} < 1200$ V	10	μs
Inverse Diode			
I_F	$T_J = 150^\circ\text{C}$	$T_{case} = 25^\circ\text{C}$	720
		$T_{case} = 80^\circ\text{C}$	500
I_{FRM}	$I_{FRM} = 2 \times I_{FRom}$	1200	A
I_{FSM}	$t_p = 10$ ms; sin. $T_J = 150^\circ\text{C}$	5700	A
Module			
$I_{T(RMS)}$		500	A
T_{vj}		-40 ... +150 (125)	$^\circ\text{C}$
T_{stg}		125	$^\circ\text{C}$
V_{test}	AC, 1 min.	4000	V

Characteristics		$T_{case} = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$; $I_C = 24$ mA	4,5	5,5	6,5	V
I_{CES}	$V_{GE} = 0$ V, $V_{CE} = V_{CES}$	$T_J = 25^\circ\text{C}$	0,2	0,6	mA
		$T_J = 125^\circ\text{C}$			
V_{CE0}		$T_J = 25^\circ\text{C}$	1,5	1,75	V
		$T_J = 125^\circ\text{C}$	1,7		V
r_{CE}	$V_{GE} = 15$ V	$T_J = 25^\circ\text{C}$	2,8	3,3	m Ω
		$T_J = 125^\circ\text{C}$	3,8	5,4	m Ω
$V_{CE(sat)}$	$I_{Crom} = 600$ A, $V_{GE} = 15$ V	$T_J = 25^\circ\text{C}_{chiplovs}$	3,2	3,75	V
		$T_J = 125^\circ\text{C}_{chiplovs}$	4		V
C_{iss}	$V_{CE} = 25$, $V_{GE} = 0$ V	$f = 1$ MHz	37		nF
C_{oss}			5,6		nF
C_{res}			2,8		nF
R_{Gint}	$T_J = ^\circ\text{C}$		1,7		Ω
$t_{(on)}$	$R_{Coff} = 0,5$ Ω	$V_{CC} = 600$ V $I_C = 600$ A	88		ns
$t_{(off)}$				$T_J = 125^\circ\text{C}$ $V_{GE} = \pm 15$ V	
E_{on}					mJ
E_{off}				48	mJ
$R_{th(j-c)}$	per IGBT			0,03	K/W



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Characteristics

Symbol	Conditions	min.	typ.	max.	Units
$V_F = V_{EC}$	$I_{FRM} = 600$ A; $V_{CE} = 0$ V $T_J = 25$ °C _{chiplev.} $T_J = 125$ °C _{chiplev.}		2,3 2,1	2,5 2,3	V
V_{FO}	$T_J = 25$ °C $T_J = 125$ °C		1,1 0,9	1,3 1,05	V
r_F	$T_J = 25$ °C $T_J = 125$ °C		2 2	2 2,1	mΩ
I_{RSM}	$I_F = 600$ A $T_J = 25$ °C		370		A
Q_{rr}			63		μC
E_{rr}	$V_{CE} = 0$ V; $V_{CC} = 600$ V		28		mJ
$R_{th(j-c)}$	per diode			0,07	K/W

Module

L_{DE}			20	nH
R_{CC+EE}	res., terminal-chip $T_{case} = 25$ °C $T_{case} = 125$ °C		0,18 0,22	mΩ mΩ
$R_{th(c-s)}$	per module			0,038 K/W
M_s	to heat sink M6	3	5	Nm
M_t	to terminals M6(M4)	2,5 (1,1)	5 (2)	Nm
w			330	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.





